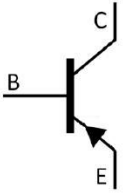


/ Descriptions

/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

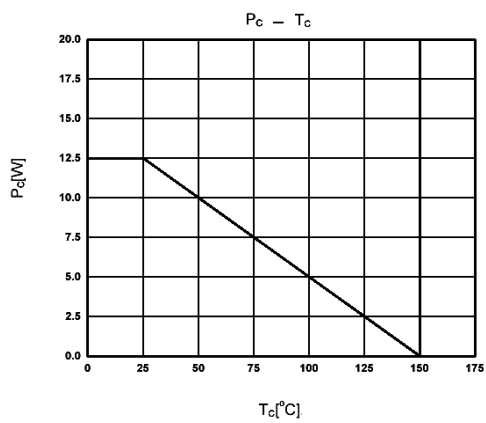
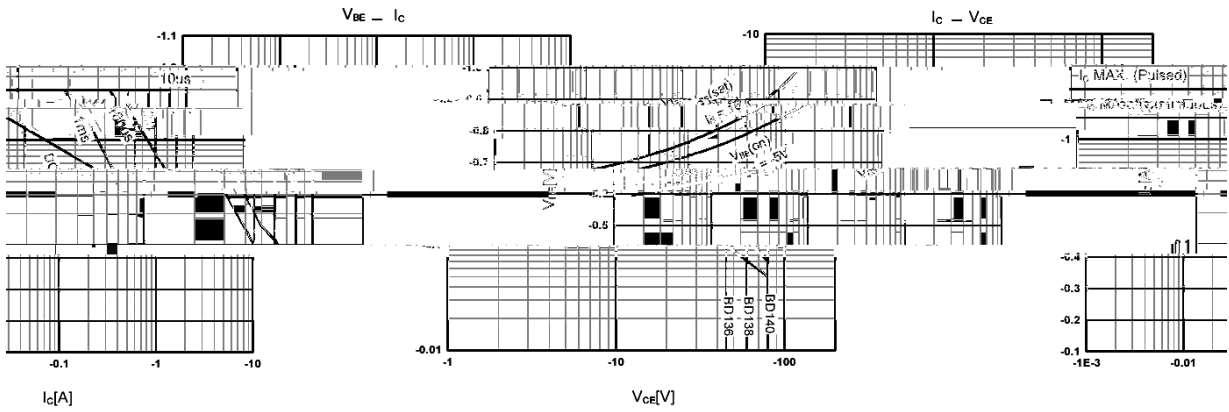
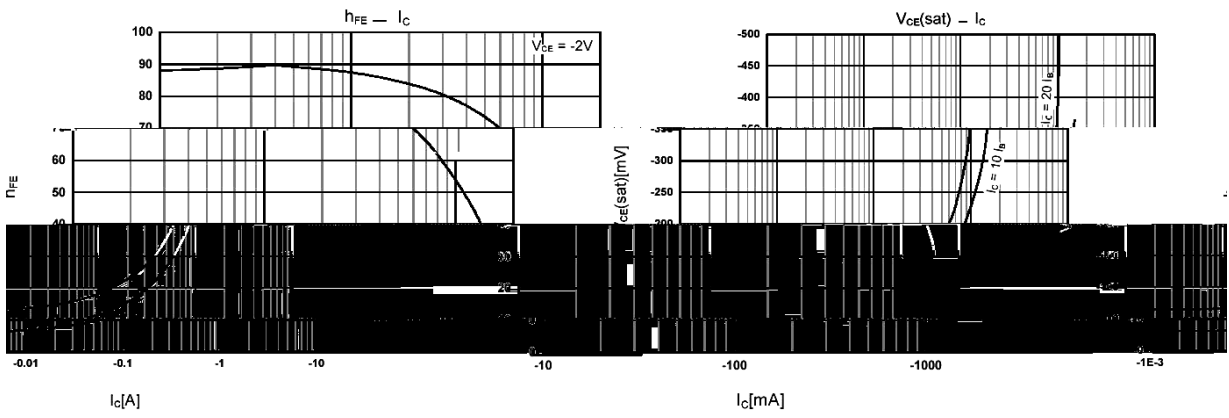


/ h_{FE} Classifications & Marking

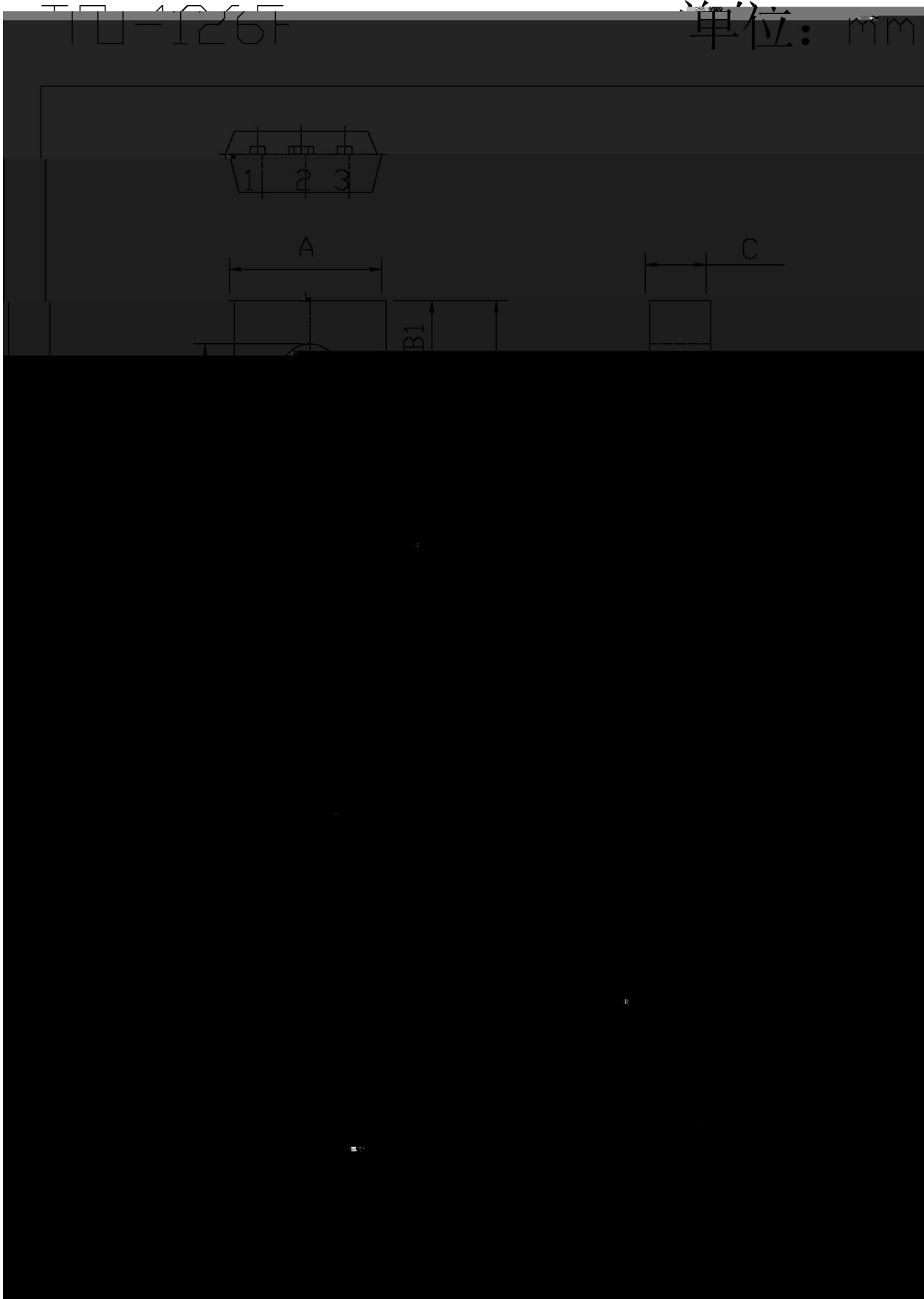
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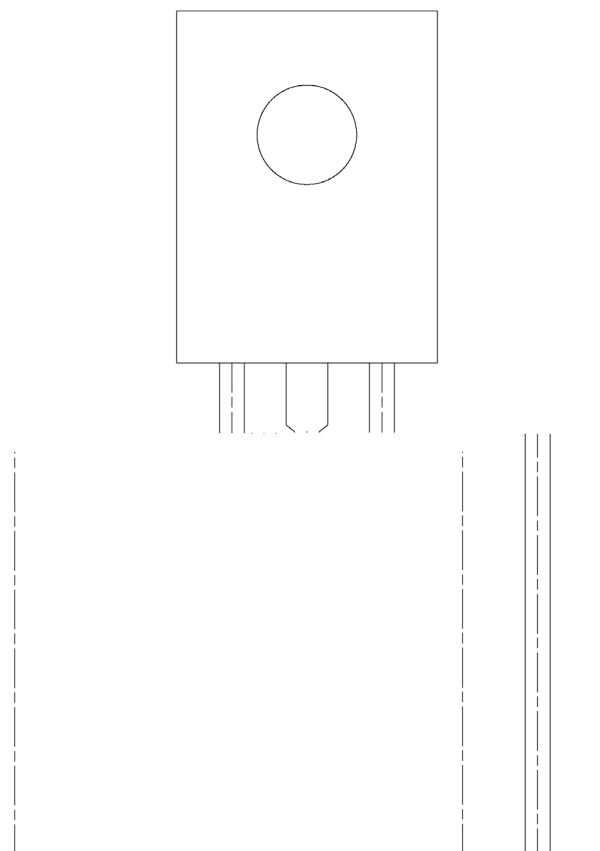
/ Electrical Characteristic Curve



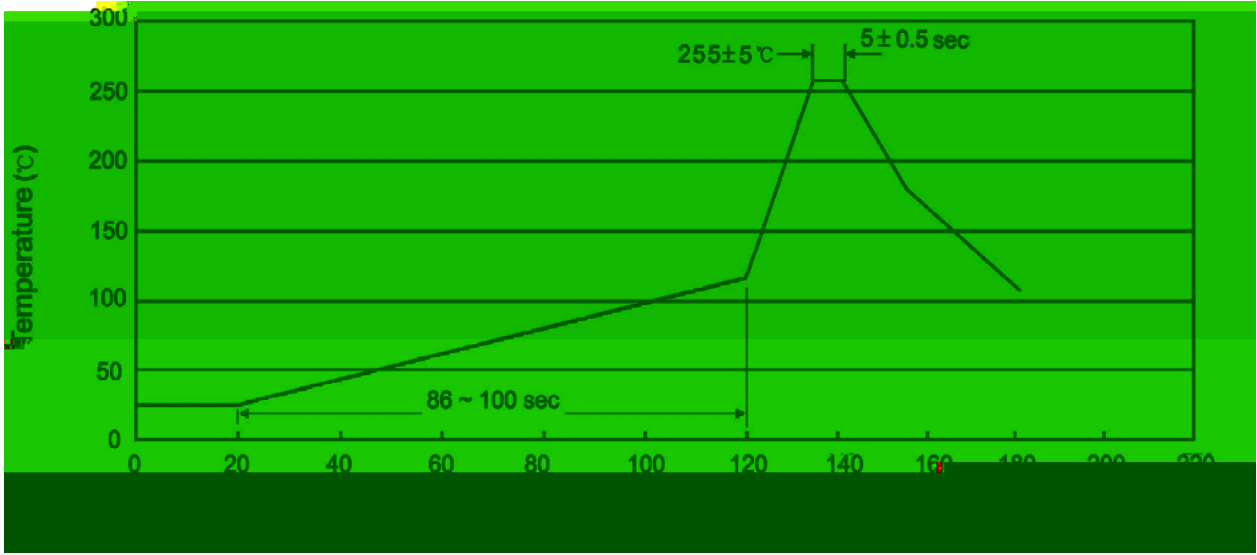
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

°C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸			
	只	套管	套管盒	只	盒	只	箱	套管	盒